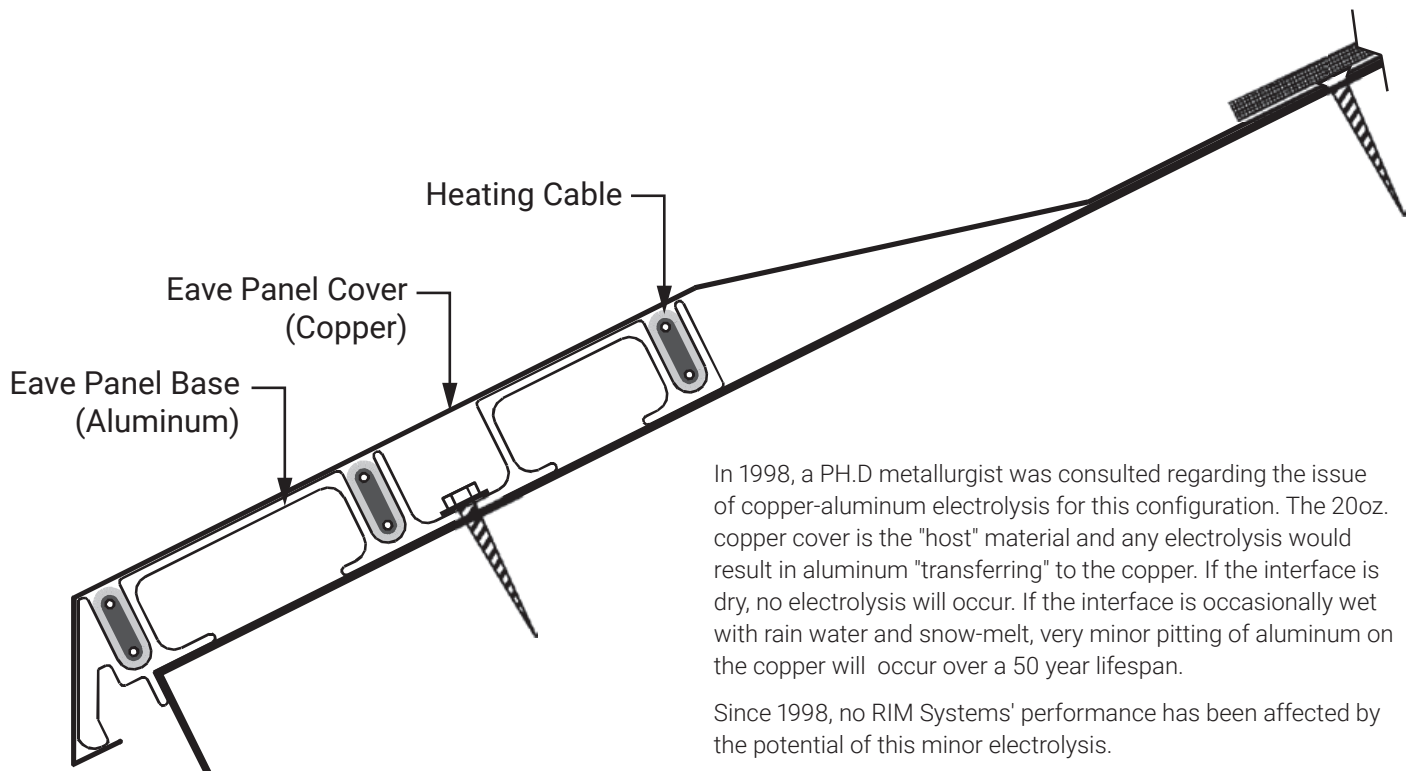


RIM/RIM 2 Systems



ELECTROLYSIS CONSIDERATION RIM ALUMINUM BASE PANEL WITH RIM COPPER COVER PANEL



In 1998, a PH.D metallurgist was consulted regarding the issue of copper-aluminum electrolysis for this configuration. The 20oz. copper cover is the "host" material and any electrolysis would result in aluminum "transferring" to the copper. If the interface is dry, no electrolysis will occur. If the interface is occasionally wet with rain water and snow-melt, very minor pitting of aluminum on the copper will occur over a 50 year lifespan.

Since 1998, no RIM Systems' performance has been affected by the potential of this minor electrolysis.

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